## **PATENT APPLICATION**

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Yoshihiro TSUCHIYA, Satoru ARAKI, Masashi SANO, Takumi UESUGI

Application No.: New U.S. Patent Application

Filed: January 26, 2001 Docket No.: 108337

For: MAGNETIC TRANSDUCER, THIN FILM MAGNETIC HEAD, METHOD OF

MANUFACTURING MAGNETIC TRANSDUCER AND METHOD OF

MANUFACTURING THIN FILM MAGNETIC HEAD

## INFORMATION DISCLOSURE STATEMENT

Director of the U.S. Patent and Trademark Office Washington, D.C. 20231

Sir:

Pursuant to 37 CFR §1.56, the attention of the Patent and Trademark Office is hereby directed to the reference(s) listed on the attached PTO-1449. Unless otherwise indicated herein, one copy of each reference is attached. It is respectfully requested that the information be expressly considered during the prosecution of this application, and that the reference(s) be made of record therein and appear among the "References Cited" on any patent to issue therefrom.

- 1. This Information Disclosure Statement is being filed (a) within three months of the U.S. filing date, OR (b) before the mailing date of a first Office Action on the merits in the present application. No certification or fee is required.
- 2. An English-language Abstract of the non-English language reference is attached hereto.

Respectfully submitted,

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Date: January 26, 2001

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IDS (Translation of Abstract for Japanese Application No Hei11-227530)

Provided are a magnetic transducer capable of increasing a resistance change and obtaining an appropriate coercive force, a thin film magnetic head, a method of manufacturing a magnetic transducer and a method of manufacturing a thin film magnetic head.

A stack comprising a spin valve film has a stacked structure comprising an underlayer, a first soft magnetic layer, a second soft magnetic layer, nonmagnetic metal layer, ferromagnetic antiferromagnetic layer and a protective layer, which are stacked in this order on the underlayer. Electrical resistance changes according to a relative angle between the orientation of magnetization of the ferromagnetic layer and the orientations of magnetizations of the first and second soft magnetic layers. A soft magnetic interlayer having magnetism and having higher electrical resistance than the electrical resistance of the first soft magnetic layer is formed (in) the first soft magnetic layer. When a current passes through the stack, electrons are reflected by a surface of the soft magnetic interlayer. Thus, a path for the electrons is narrowed, and therefore the rate of resistance change increases.

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Sheet 1 of 1

Form PTO-1449 (REV. 8-83)	US Dept. of Commerce PATENT & TRADEMARK OFFICE	108337	DOCKET NO.	APPLICATION NO. New U.S. Patent Application		
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U.S. PATENT DOCUMENTS						
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OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, etc.)						
	"CoFe SPECULAR SPIN VALVES WITH A NANO OXIDE LAYER", Kamiguchi et al., 1999 Digests of INTERAMG					
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